









# ■ Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10μA 1V DC
Initial contact resistance	500mΩ max.
Travel (mm)	0.25

# ■ Product Line

### Top push type

Product No.	Operating force	Operating direction	Operating life	Minimum order unit (pcs.)		
T TOUGOT NO.	Operating force	Operating direction	(5mA 5V DC)	Japan	Export	
SKQYACE010	0.98N					
SKQYAAE010	1.57N	Top push	50,000 cycles	3,000	3,000	
SKQYABE010	2.55N	τορ ρασιτ				
SKQYAFE010	3.14N					

# With ground terminal type

Product No.	Operating force	Operating direction	Operating life	Minimum order unit (pcs.)		
T TOUGET NO.	Operating force	Operating direction	(5mA 5V DC)	Japan	Export	
SKQYPCE010	0.98N					
SKQYPAE010	1.57N	Top push	F0.000 avalas	3,000	3,000	
SKQYPBE010	2.55N	τορ ραστι	50,000 cycles			
SKQYPDE010	3.14N					

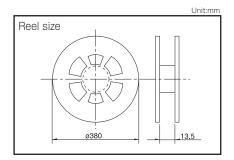
# ■ Packing Specifications

### Taping

Number of packages (pcs.)			Tape width	Export package
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
3,000	30,000	30,000	12	395×395×205

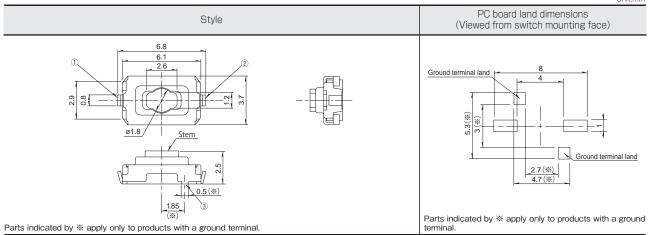
# Note

For reels of 330mm diameter, please inquire.

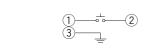


# Dimensions

Unit:mm



### ■ Circuit Diagram



Parts indicated by  $\ensuremath{\mathfrak{J}}$  apply only to products with a ground terminal.

					Sharp Fe	eling Type			
	Type				Surface	e Mount			
	Series	SKRK	SKTH	SKRP	SKQM	SKQY	SKTQ	SKTR	SKSU
	Photo		1				NEW		
	Features	Compact size Low-profile	Compact size	High operation force Compact size	Compa	act size		Middle travel	
	Water-proof	_	_	_	_	_	_	_	•
	Dustproof	_	•	_	_	_	_	_	•
	IP standard	_	_	_	_	_	_	_	67 equivalent
Operatir	Top push	•	•	•	•	•	•	•	•
directio		_	_	_	_	_	_	_	_
	W	3.9	3.5	4.2	6	6.1	5.3		5.3
Dimensio (mm)		2.9	3	.2	3.5	3.7	5.4	□6.1	5.4
(11111)	Н	1.5/2	1.8/2.5	2.5	4.3/5	2.5	4.25	4.1	3.85/4.34
Operation force coverage	2N to 3N	Ţ			Ţ		1	<b>‡</b>	<b>‡</b>
	Travel (mm)	0.13	0.12	0.2	0.	25	0.71	0.72	0.7/0.9
G	round terminal	_	_	_	_	0	_	_	_
Operatin	ng temperature range	-40℃ to +85℃			-	-40°C to +90°	°C		
А	utomotive use	_	•	•	•	•	•	•	•
	Life Cycle	<b>*</b> 2	<b>*</b> 2	*3	<b>*</b> 2	<b>*</b> 2	*3	*3	**3
	Rating (max.) (Resistive load)	50mA 12V DC					С		
Electrical	Rating (min.) (Resistive load)				10μΑ	1V DC			
performance	Insulation resistance		100MΩ min. 100V DC 1min.						
	Voltage proof	250V AC 1min.	100V AC 1min.			250V A	AC 1min.		
Durability	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively							
Durability	Lifetime	Shall be in accordance with individual specifications.							
	Cold	-40°C 96h -4		-40℃ 1,000h	-40°C 96h		-40℃ 1,000h		1
Environmental performance	Dry heat	90°C 96h		90°C 1,000h	90°C 96h		90℃ 1,000h		
	Damp heat	60°C, 90 to 95%RH 96h		90 to 95%RH	1,000h				
	Page	204	206	208	210	211	213	214	215

W: Width. The most outer dimension excluding terminal portion. D: Depth. The most outer dimension excluding terminal portion.

H: Height. The minimum dimension if there are variances.

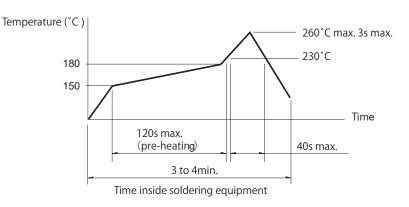
TACT Switch™ Soldering Conditions · · · · · · · · · · · · · · · · · · ·
TACT Switch™ Cautions · · · · · · · · · · · · · · · · · · ·

 $<sup>\</sup>hbox{1. The automotive operating temperature range to be individually discussed upon request.}\\$ 

<sup>2. •</sup> Indicates applicability to all products in the series, while  $\bigcirc$  indicates applicability to some products in the series.

# TACT Switch™ / Soldering Conditions

# ■ Condition for Reflow Available for Surface Mount Type. Temperature profile



# Notes

- 1. Please confirm the specifications of our product for the detailed condition.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

### ■ Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

### **SKHH Series**

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110℃ max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

### SKHL Top Push Type, SKQJ Series

Items	Condition	
Flux built-up	Mounting surface should not be exposed to flux	
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.	
Preheating time	45s max.	
Soldering temperature	255℃ max.	
Duration of immersion	5s max.	
Number of soldering	2times max.	

# ■ Manual Soldering

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

### SKHH, SKHW Series

Items	Condition
Soldering temperature	360℃ max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

### SKTD, SKTG, SKQJ, SKSN Series

Items	Condition
Soldering temperature	350℃ max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

### Notes

- 1. Prevent flux penetration from the top side of the TACT Switch $^{TM}$ .
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81.

(EC-19S-8 by TAMURA CORPORATION, or equivalents.)